MATERIALS AND FINISHES

BODY: BRASS
PLATED NICKEL

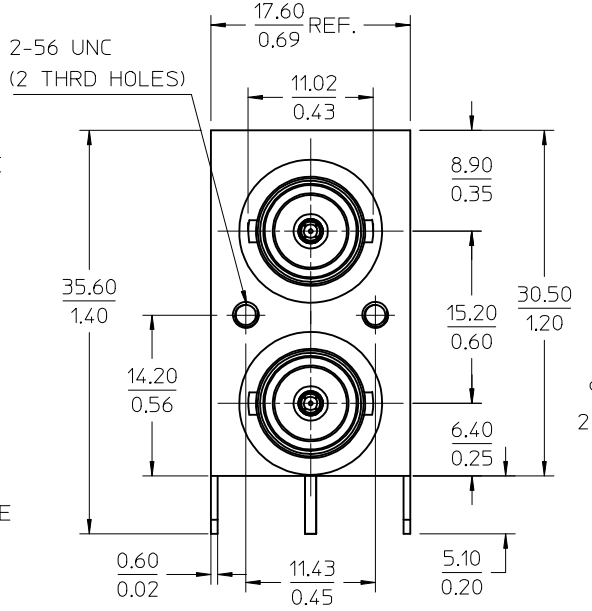
CENTER CONTACT: PHOSPHOR BRONZE
PLATED GOLD

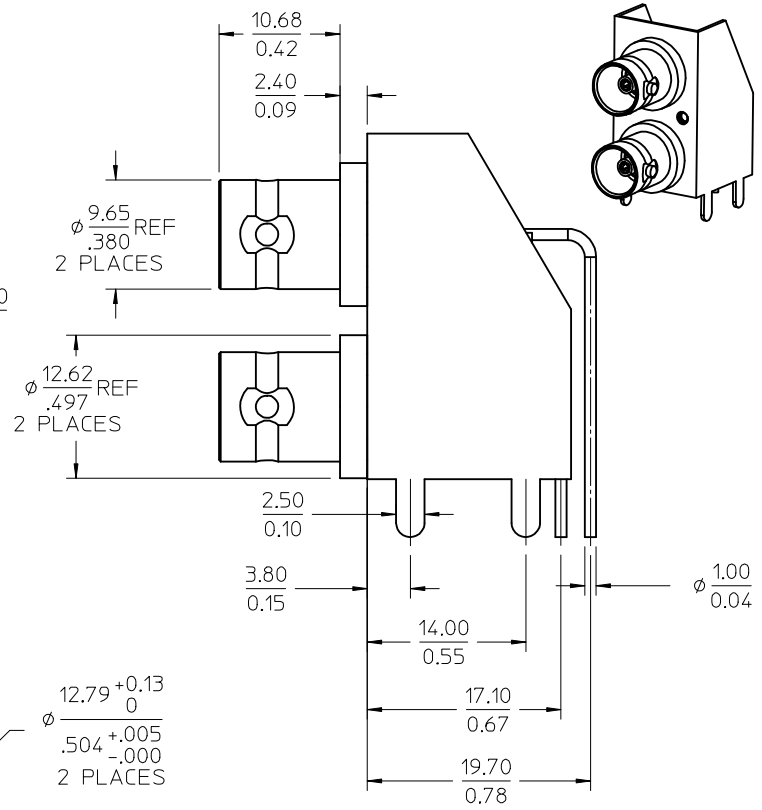
INSULATOR: TEFLON

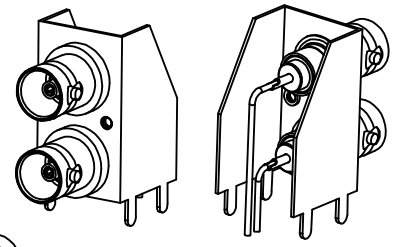
PRESS RING: STEEL
PASSIVATE

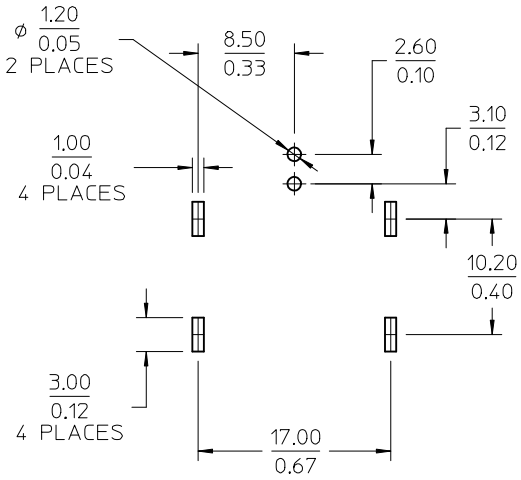
BRACKET: SPCC
PLATED NICKEL

GROUNDING: COPPER OVER STEEL WIRE
PLATED TIN

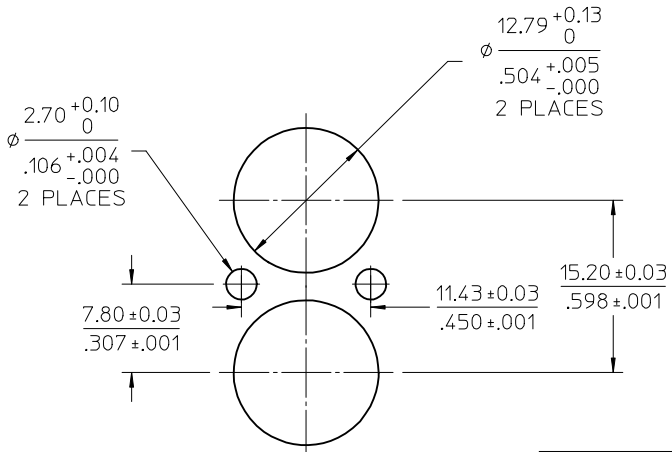








RECOMMENDED PCB LAYOUT



RECOMMENDED
PANEL CUT-OUT
PANEL THK: 2.00/.079 MAX.

PS-73598-0051	ELEC/MECH PERFORMANCE
MIL-STD-348A, FIG. 301.2	INTERFACE
SPECIFICATION	DESCRIPTION

73415-3981	1 PC PER BAG
73415-3980	TRAY
PART NO.	PACKAGING

CHG: ADDED PANEL CUTOUT PER RF15-E253 2015/07/23
EC NO: URF2016-0007 2015/07/09
DRWN: EWE102
CHKD:
APPR: YCHENG
DESCRIPTION
REV
A4

QUALITY SYMBOLS

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
0 PLACE	±	±

ANGULAR ± 2 °

DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS

DIMENSION STYLE: MM/IN
SCALE
DESIGN UNITS: METRIC
THIRD ANGLE PROJECTION

DRAWN BY: CLL I DATE: 2003/09/08
CHECKED BY: - DATE: 2003/09/08
APPROVED BY: - DATE: 2003/09/08

TITLE: BNC 75 OHMS JACK DUAL
BNC-J/PCB

molex

MATERIAL NO.: SEE TABLE
DOCUMENT NO.: SD-73415-398
SHEET NO.: 1 OF 1
SIZE: C

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